

TECHNOLOGY DAYS 2015 PROGRAM

22nd April

8:00 am Entrance 8:45 Scheugenpflug product portfolio presentation by the sales team 9:30 Silicones for power electronics Dr. Markus Jandke, Wacker Chemie AG A new generation of silicone gap filler and adhesives 10:30 for more efficient processing Sandrine Teixeira de Carvalho, Senior Automotive Electronics Application Engineer, Dow Corning Europe SA 11:30 Application of atmospheric plasma technology in the electronic industry Dipl.-Ing. (FH) Werner Krammel, Plasmatreat GmbH 12:15 New Polyurethane- and Epoxy Resins for High **Temperature Applications** Dr. Peter Gräter, WEVO-CHEMIE GmbH Technical Service - five most common errors in 1:30 pm maintenance, supportive tools, hotline support Scheugenpflug AG 2:30 Total encapsulation of electronic drives Ulf Koschmieder, Sales Engineer, ELANTAS Beck GmbH 3:30 Epoxy- and Polyurethane-based Encapsulants for automotive applications Dr. Werner Hollstein, Technical Support Electronic & Electrical Engineering, Huntsman Advanced Materials GmbH 4:30 Optimized Epoxy Casting Resins for Highly Reliable Automotive Sensors with Increased Environmental Requirements Dipl.-Ing. (FH) Martin Böttcher, DELO Industrial Adhesives GmbH & Co. KGaA 5:30 Trends on thermal conductive Liquids. Product requirements, Applications, Process Holger Schuh, BQ EU Liquid and Dispensing Expert, The Bergquist Company GmbH

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Entrance

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8:45		Scheugenpflug product portfolio presentation by the sales team
9:30	I	Epoxy- and Polyurethane-based Encapsulants for automotive applications Dr. Werner Hollstein, Technical Support Electronic & Electrical Engineering, Huntsman Advanced Materials GmbH
10:30		Total encapsulation of electronic drives Ulf Koschmieder, Sales Engineer, ELANTAS Beck GmbH
11:30	I	Trends on thermal conductive Liquids. Product requirements, Applications, Process Holger Schuh, BQ EU Liquid and Dispensing Expert, The Bergquist Company GmbH
1:30 pm	1	Optimized Epoxy Casting Resins for Highly Reliable Automotive Sensors with Increased Environmental Requirements Dr. rer. nat. Markus Nimmrich, DELO Industrial Adhesives GmbH & Co. KGaA
2:30	ı	Technical Service – five most common errors in maintenance, supportive tools, hotline support Scheugenpflug AG
3:30	I	Silicones for power electronics Dr. Markus Jandke, Wacker Chemie AG
4:30	I	A new generation of silicone gap filler and adhesives for more efficient processing Sandrine Teixeira de Carvalho, Senior Automotive Electronics Application Engineer, Dow Corning Europe SA
5:30	I	Application of atmospheric plasma technology in the electronic industry DiplIng. (FH) Werner Krammel, Plasmatreat GmbH

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